Electronic Acknowledgement Receipt				
EFS ID:	1395905			
Application Number:	10653556			
International Application Number:				
Confirmation Number:	3225			
Title of Invention:	Contact structure of semiconductor device, manufacturing method thereof, thin film transistor array panel including contact structure, an manufacturing method thereof			
First Named Inventor/Applicant Name:	Bum-Gee Baek			
Customer Number:	23413			
Filer:	James J. Merrick/Shenita Carroll			
Filer Authorized By:	James J. Merrick			
Attorney Docket Number:	YOM-0051			
Receipt Date:	22-DEC-2006			
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Time Stamp:	12:12:18			
Application Type:	Utility			

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Amendment - After Non-Final Rejection	Response_YOM-0051.pdf	475809	no	6
Warnings:					

Information:	
Total Files Size (in bytes):	475809

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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.